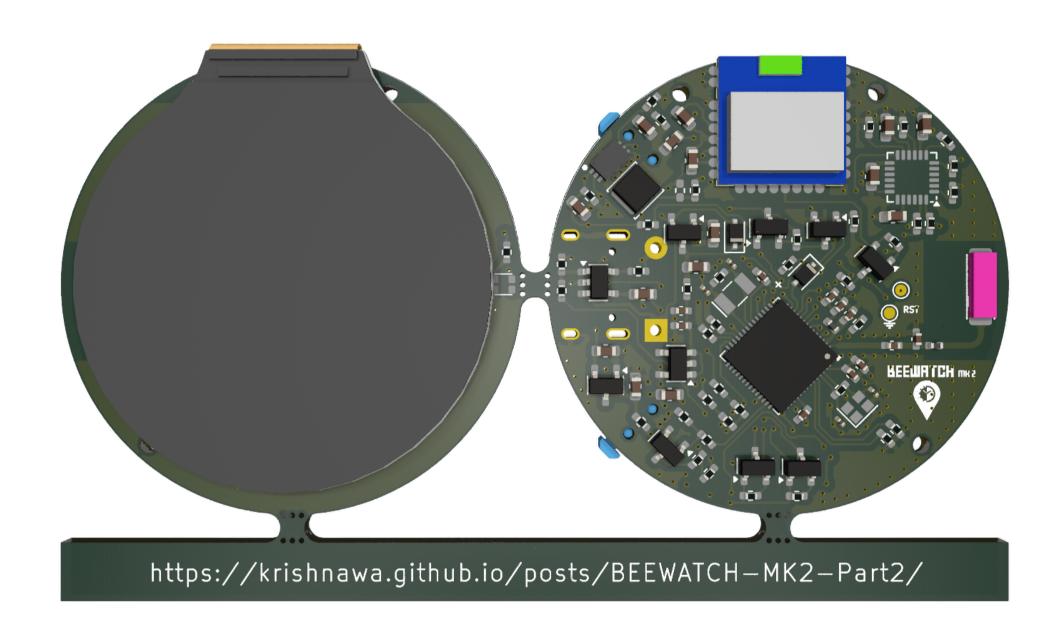
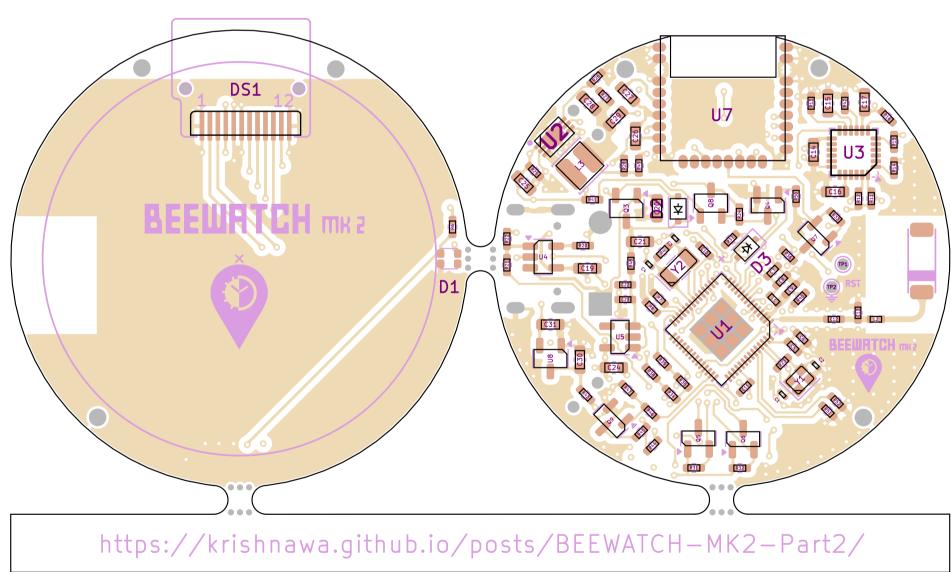
Top Assembly (Scale 1:3)

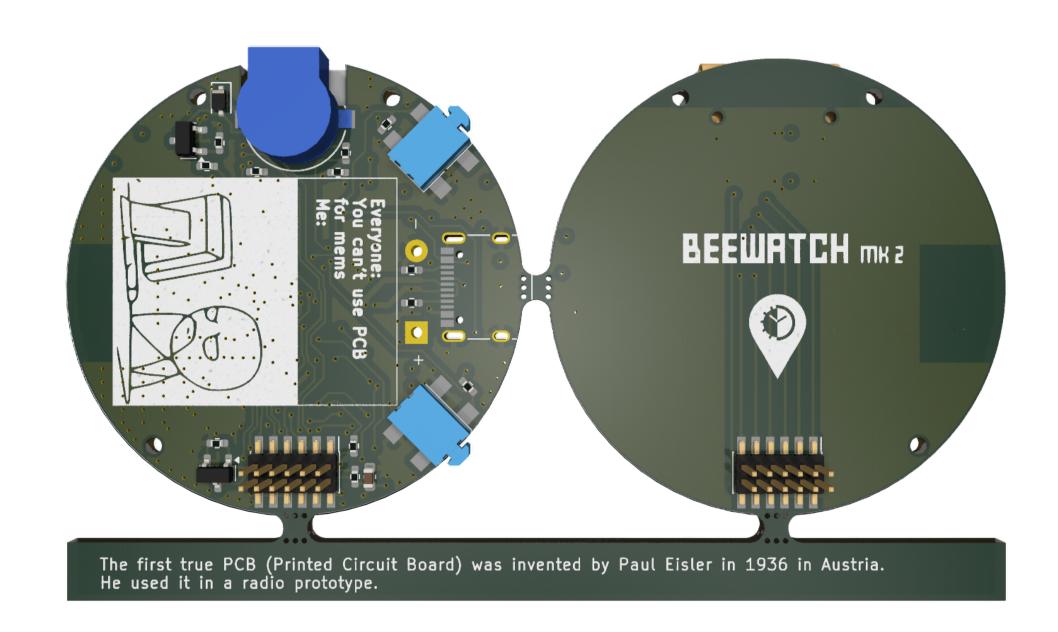


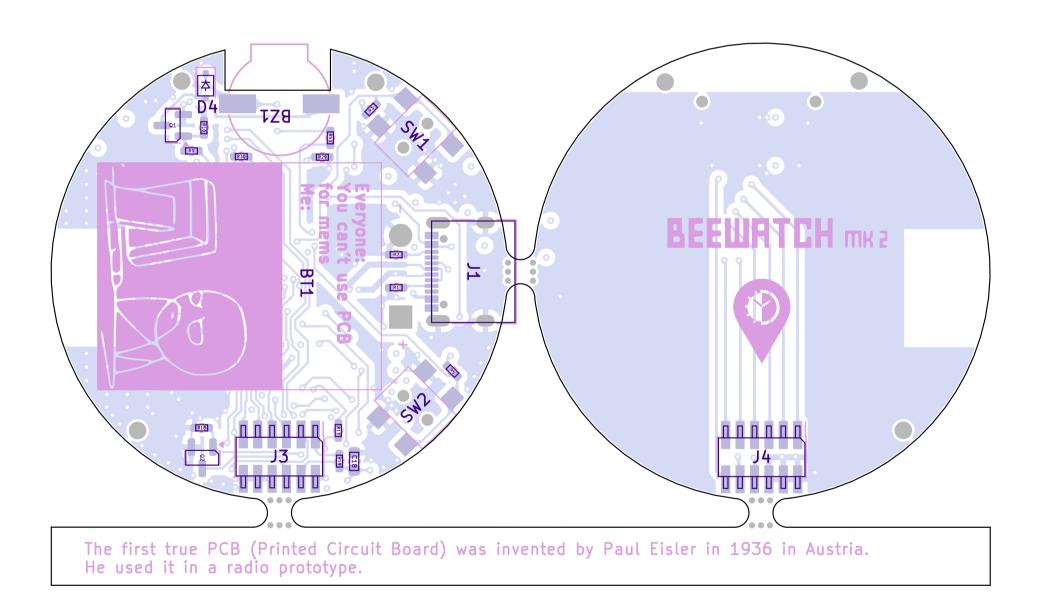


ASSEMBLY NOTES (UNLESS OTHERWISE SPECIFIED)

- 1. All components must be placed and soldered as per the latest Bill of Materials (BOM) and assembly drawings.
- 2. Unless otherwise specified, all polarized components (diodes, electrolytic capacitors, etc.) must be assembled with correct orientation.
- 3. Ensure correct placement and orientation of ICs, connectors, and LEDs as per silkscreen markings.
- 4. Clean the PCB after soldering to remove all flux residues and contaminants.
- 5. Use ESD-safe practices during handling and assembly of the PCB.
- 6. Do not substitute components without prior approval.
- 7. Verify all mechanical components (connectors, switches, etc.) for correct alignment and secure fitting.
- 8. Apply solder paste using the stencil provided or per Gerber paste layer.
- 9. Follow IPC-A-610 Class 2 (or Class 3, if applicable) workmanship standards.
- 10. All surface-mount components should be reflow soldered. Through-hole components should be hand-soldered unless specified otherwise.
- 11. No visible solder bridges, cold joints, or misalignments are allowed.
- 12. All assembled PCBs must pass visual inspection and functional testing (if applicable).
- 13. Include fiducials on board corners for pick-and-place machine alignment.
- 14. Do not apply conformal coating unless instructed.
- 15. Handle boards by the edges. Avoid touching component surfaces.

Bottom Assembly (Scale 1:3)





Board2Pdf: Bottom ASSY - Page 2/2

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Sheet: Bottom ASSY
File: BEEWATCH MK2.kicad_pcb

Title: BEEWATCH MK2

Size: A1 Date: 2025-04-24 Rev: A
KiCad E.D.A. 9.0.2 Id: /1